



SR30200LCT,SRF30200LCT,SR30200LD1

LOW VF SCHOTTKY BARRIER RECTIFIER

Reverse Voltage - 200 Volts

Forward Current - 30.0Amperes

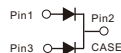
FEATURES

- Power pack
- Metal silicon junction ,majority carrier conduction
- Guard ring for overvoltage protection
- Low power loss ,high efficiency
- High current capability ,low forward voltage drop
- High forward surge capability
- High frequency operation
- Meets MSL Level 1, per J-STD-020, LF MAX peak of 245°C (for TO-263 package)
- Solder bath temperature 275°C maximum, 10s, per JESD22-B106 (for TO-220AB and ITO-220AB package)
- Component in accordance to RoHS 2011/65/EU



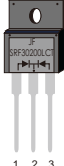
TO-220AB

SR30200LCT



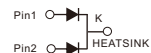
ITO-220AB

SRF30200LCT



TO-263

SR30200LD1



MECHANICAL DATA

- Case: JEDEC TO-220AB, ITO-220AB, TO-263
- Molding compound meets UL94V-0 flammability rating
- Terminals: Lead solderable per J-STD-002 and JESD22-B102
- Polarity: As marked
- Mounting Torque: 10 in-lbs maximum

TYPICAL APPLICATIONS

For use in low voltage ,high frequency inverters ,DC/DC converters, free wheeling ,and polarity protection applications

MAXIMUM RATINGS

(Ratings at 25°C ambient temperature unless otherwise specified)

Parameter	Symbol	Value	Unit
Maximum repetitive peak reverse voltage	V_{RRM}	200	V
Maximum average forward rectified current (see fig.1)	$I_F(AV)$	15.0	A
		30.0	
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC method at rated T_J)	I_{FSM}	250	A
Peak repetitive reverse current per diode at $t_p=2\mu s$ 1KHz	I_{RRM}	0.5	A
Operating junction and Storage temperature range	T_J, T_{stg}	-55 to+150	°C
Isolation voltage (ITO-220AB only) from terminals to heatsink $t=1$ min	V_{AC}	1500	V

PRIMARY CHARACTERISTICS

$I_F(AV)$	$2 \times 15A$
V_{RRM}	200V
I_{FSM}	250A
V_F at $I_F=15.0A$,Per leg	0.88V
I_R	$5\mu A$
$T_J(MAX)$	150°C
Package	TO-220AB, ITO-220AB, TO-263
Diode variations	Common cathode

RATINGS AND CHARACTERISTIC OF SR30200LCT,SRF30200LCT,SR30200LD1

ELECTRICAL CHARACTERISTCS (TA=25℃ Unless otherwise noted)

Parameter	Test Conditions		Symbol	TYP.	MAX.	Unit
Instaneous forward voltage	Per leg IF=15.0A	TA=25℃	VF ¹⁾	—	0.88	V
		TA=100℃		—	0.78	
		TA=125℃		0.72	0.75	
	Per leg IF=10.0A	TA=25℃		—	0.83	
		TA=100℃		—	0.73	
		TA=125℃		0.65	0.68	
Reverse current	VR=200V	TA=25℃	IR ²⁾	5	20	μA
		TA=100℃		0.3	1	mA
		TA=125℃		1	2	
Typical junction capacitance	4V, 1MHz		CJ	300		pF

Notes: 1.Pulse test: 300 μs pulse width,1% duty cycle
2.Pulse test: pulse width≤40ms

THERMAL CHARACTERISTCS

Parameter	Symbol	SR30200LCT	SRF30200LCT	SR30200LD1	Unit
Typical thermal resistance ³⁾	RθJC	2.5	4.5	2.5	℃/W

3.Thermal resistance from junction to case

AVAILABALE PACK INFORMATION

Product code	Pack	Box Size L×W×H(mm)	Quantity(pcs/box)	Carton SizeL×W×H(mm)	Quantity(box/carton)
SR30200LCT-TO-220AB	P/T	558×148×38	1000	565×225×170	5
SRF30200LCT-ITO-220AB	P/T	558×148×38	1000	565×225×170	5
SR30200LD1-TO-263	P/T	558×148×38	1000	565×225×170	5

RATINGS AND CHARACTERISTIC OF SR30200LCT,SRF30200LCT,SR30200LD1

FIG.1-FORWARD CURRENT DERATING CURVE

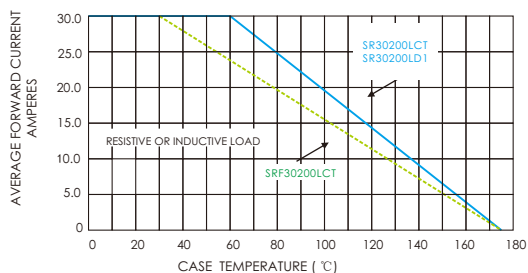


FIG.2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

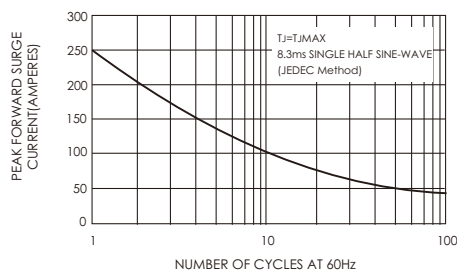


FIG.3-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

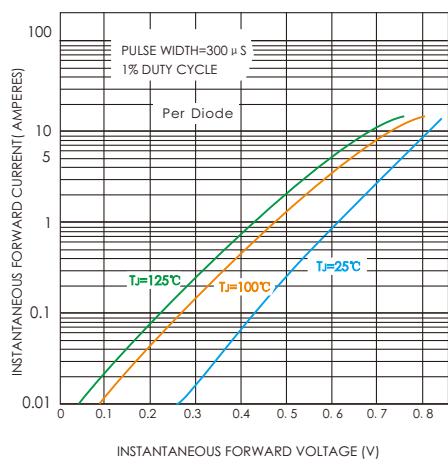


FIG.4-TYPICAL REVERSE CHARACTERISTICS

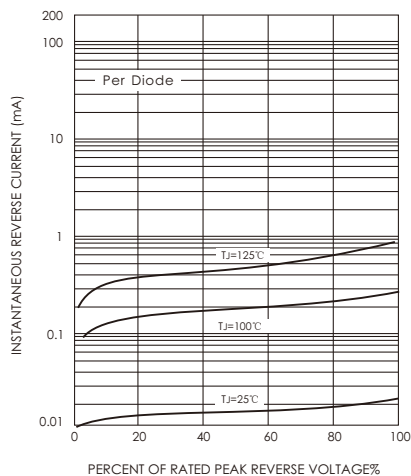
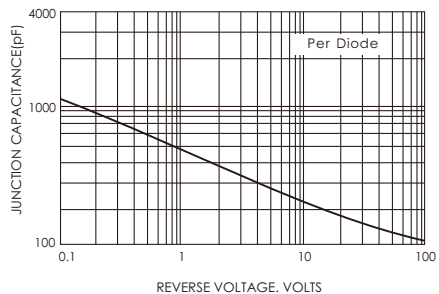
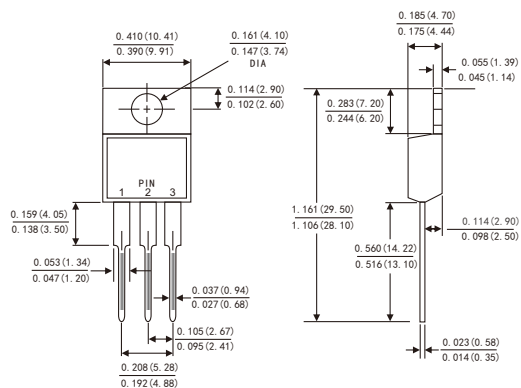


FIG.5-TYPICAL JUNCTION CAPACITANCE

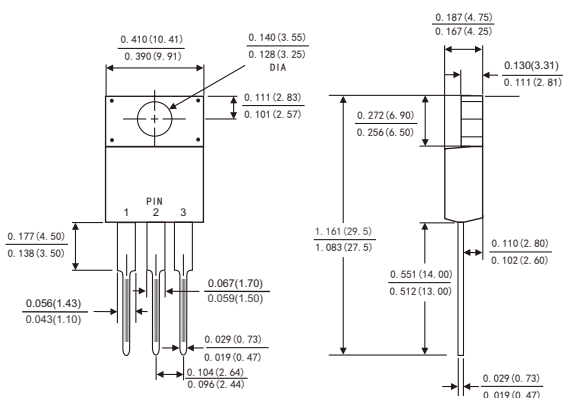


PACKAGE OUTLINE DIMENSIONS

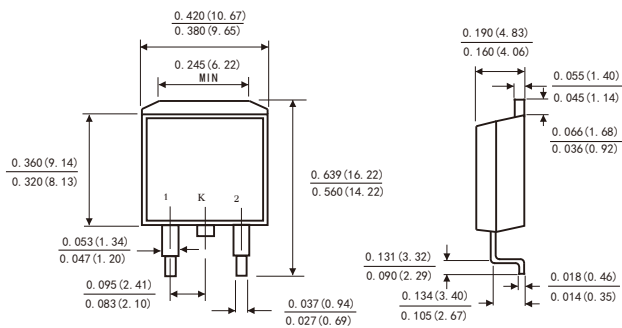
TO-220AB



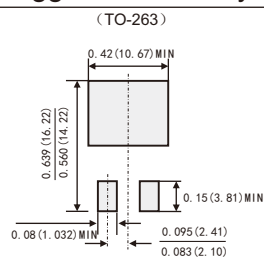
ITO-220AB



TO-263



Suggested Pad Layout



Dimensions in inches and (millimeters)